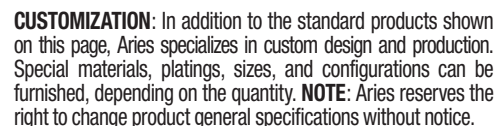




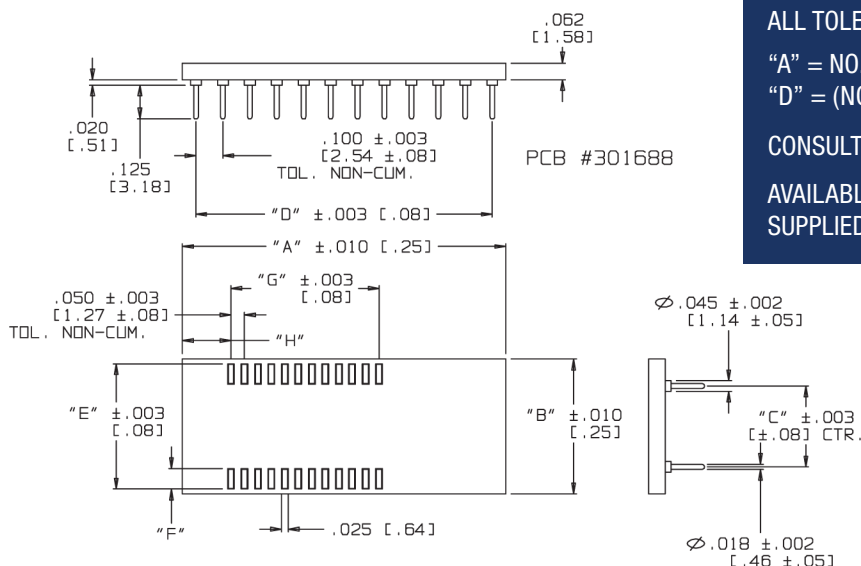
- Pb-Free RoHS/WEEE-Compliant
- A cost-effective means of upgrading to SOIC without changing your PCB layout
- Available on 0.300 [7.62] centers. Consult **Data Sheet 18011** for Adapters on 0.400 [10.16], or 0.600 [15.24] centers.

- BOARD MATERIAL: 0.062 [1.58] thick FR-4 or IS410 per IPC 4101A/26 with 1-oz. Cu traces, both sides finished with ENIG (Immersion Au over electroless Ni)
- PINS: Brass 360 1/2-hard per UNS C36000, ASTM B16/B16M
- PIN PLATING: 10μ [0.254μ] Au per MIL-G-45204 over 100μ [2.54μ] Ni per SAE AMS-QQ-N-290
- OPERATING TEMPERATURE: 221°F [105°C]

- SUGGESTED PCB HOLE SIZE: 0.035 ± 0.002 [0.89 ± 0.05] dia.



See Table below for P/Ns



AVAILABLE IN PANELIZED FORM WITH OR WITHOUT CUSTOMER-SUPPLIED DEVICES MOUNTED. CONSULT FACTORY.

P/N	Pins	Type	Dim. "B"	Centers "C"	Dim. "E"	Dim. "F"	Dim. "G"	Dim. "H"
14-35W000-11-RC	14	SOIC	0.500 [12.70]	0.300 [7.62]	0.465 [11.81]	0.076 [1.93]	0.500 [12.70]	0.180 [4.57]
16-35W000-11-RC	16	SOIC	0.500 [12.70]	0.300 [7.62]	0.465 [11.81]	0.076 [1.93]	0.550 [13.97]	0.180 [4.57]
18-35W000-11-RC	18	SOIC	0.500 [12.70]	0.300 [7.62]	0.465 [11.81]	0.076 [1.93]	0.550 [13.97]	0.180 [4.57]
20-35W000-11-RC	20	SOIC	0.500 [12.70]	0.300 [7.62]	0.465 [11.81]	0.076 [1.93]	0.550 [13.97]	0.180 [4.57]
24-35W000-11-RC	24	SOIC	0.500 [12.70]	0.300 [7.62]	0.465 [11.81]	0.076 [1.93]	0.550 [13.97]	0.180 [4.57]
28-35W000-11-RC	28	SOIC	0.500 [12.70]	0.300 [7.62]	0.465 [11.81]	0.076 [1.93]	0.550 [13.97]	0.180 [4.57]



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